SPECIFICATIONS FOR NICHIA CHIP TYPE WHITE LED MODEL: NECWB205T

NICHIA CORPORATION

 $(Ta=25^{\circ}C)$

1.SPECIFICATIONS

(1) Absolute Maximum Ratings			(Ta=25°C)
Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	IF	20	mA
Pulse Forward Current	IFP	70	mA
Reverse Voltage	VR	5	V
Power Dissipation	Pd	80	mW
Operating Temperature	Topr	-20 ~ + 85	°C
Storage Temperature	Tstg	-30 ~ +100	°C
Soldering Temperature	Tsld	Reflow Soldering : 260°C	for 10sec.
		Hand Soldering : 350°C	for 3sec.
	< 10	Hand Soldering : 350°C	for 3

IFP Conditions : Pulse Width ≤ 10 msec. and Duty $\leq 1/10$

(2) Initial Electrical/Optical Characteristics

Item		Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage		VF	IF=10[mA]	-	3.6	4.0	V
Reverse Current		Ir	VR = 5[V]	-	-	50	μA
	Rank R	Iv	IF=10[mA]	162	-	232	mcd
Luminous Intensity	Rank Q	Iv	IF=10[mA]	116	-	162	mcd
	Rank P	Iv	IF=10[mA]	81	-	116	mcd

* Luminous Intensity Measurement allowance is \pm 10%.

Color Ranks

	Rank a0				
Х	0.280	0.264	0.283	0.296	
У	0.248	0.267	0.305	0.276	
	Rank b2				
Х	0.296	0.287	0.330	0.330	
у	0.276	0.295	0.339	0.318	

	(IF=10mA,Ta=25°C)						
	Rank b1						
Х	0.287	0.287 0.283 0.330 0.330					
у	0.295	0.305	0.360	0.339			
	Rank c0						
Х	0.330	0.330	0.361	0.356			
у	0.318	0.360	0.385	0.351			

* Color Coordinates Measurement allowance is ± 0.01 .

* One delivery will include up to two consecutive color ranks and three luminous intensity ranks of the products. The quantity-ratio of the ranks is decided by Nichia.

2.TYPICAL INITIAL OPTICAL/ELECTRICAL CHARACTERISTICS Please refer to figure's page.

3.OUTLINE DIMENSIONS AND MATERIALS

Please refer to figure's pa	age.		
Material as follows ;	Package	:	BT Resin
	Encapsulating Resin Electrodes	: :	Epoxy Resin (with Diffused + YAG Phosphor) Au Plating

4.PACKAGING

 \cdot The LEDs are packed in cardboard boxes after taping.

Please refer to figure's page.

The label on the minimum packing unit shows ; Part Number, Lot Number, Ranking, Quantity

 \cdot In order to protect the LEDs from mechanical shock, we pack them in cardboard boxes for transportation.

- The LEDs may be damaged if the boxes are dropped or receive a strong impact against them, so precautions must be taken to prevent any damage.
- \cdot The boxes are not water resistant and therefore must be kept away from water and moisture.
- · When the LEDs are transported, we recommend that you use the same packing method as Nichia.

5.LOT NUMBER

The first six digits number shows **lot number**.

The lot number is composed of the following characters;

 $\bigcirc \Box \times \times \times \times \cdot \bigtriangleup \blacksquare$

O - Year (3 for 2003, 4 for 2004)

- \Box Month (1 for Jan., 9 for Sep., A for Oct., B for Nov.)
- $\times \times \times \times$ Nichia's Product Number
 - \triangle Ranking by Color Coordinates
 - Ranking by Luminous Intensity

6.RELIABILITY (1) TEST ITEMS AND RESULTS

Method A ED-4701 00 301 A ED-4701 00 303 A ED-4701 00 307 A ED-4701 00 105 A ED-4701 00 203 A ED-4701 00 203	Test Conditions Tsld=260°C, 10sec. (Pre treatment 30°C, 70%,168hrs.) Tsld=215 \pm 5°C, 3sec. (Lead Solder) 0°C ~ 100°C 15sec. 15sec. -30°C ~ 25°C ~ 100°C ~ 25°C 30min. 5min. 30min. 5min. 25°C ~ 65°C ~ -10°C 90%RH 24hrs./1cycle Ta=100°C	Note2 times1 timeover 95%20 cycles100 cycles10 cycles100 cycles	Damaged 0/50 0/50 0/50 0/50 0/50
00 301 A ED-4701 00 303 A ED-4701 00 307 A ED-4701 00 105 A ED-4701 00 203 A ED-4701	(Pre treatment 30°C, 70%,168hrs.) Tsld=215 ± 5°C, 3sec. (Lead Solder) 0°C ~ 100°C 15sec. 15sec. -30°C ~ 25°C ~ 100°C ~ 25°C 30min. 5min. 30min. 5min. 25°C ~ 65°C ~ -10°C 90%RH 24hrs./1cycle	1 time over 95%20 cycles100 cycles10 cycles	0/50 0/50 0/50
A ED-4701 00 303 A ED-4701 00 307 A ED-4701 00 105 A ED-4701 00 203 A ED-4701	Tsld=215 ± 5°C, 3sec. (Lead Solder) 0°C ~ 100°C 15sec. 15sec. -30°C ~ 25°C ~ 100°C ~ 25°C 30min. 5min. 30min. 5min. 25°C ~ 65°C ~ -10°C 90%RH 24hrs./1cycle	over 95%20 cycles100 cycles10 cycles	0/50
00 303 A ED-4701 00 307 A ED-4701 00 105 A ED-4701 00 203 A ED-4701	(Lead Solder) 0°C ~ 100°C 15sec. 15sec. -30°C ~ 25°C ~ 100°C ~ 25°C 30min. 5min. 30min. 5min. 25°C ~ 65°C ~ -10°C 90%RH 24hrs./1cycle	over 95%20 cycles100 cycles10 cycles	0/50
00 303 A ED-4701 00 307 A ED-4701 00 105 A ED-4701 00 203 A ED-4701	(Lead Solder) 0°C ~ 100°C 15sec. 15sec. -30°C ~ 25°C ~ 100°C ~ 25°C 30min. 5min. 30min. 5min. 25°C ~ 65°C ~ -10°C 90%RH 24hrs./1cycle	over 95%20 cycles100 cycles10 cycles	0/50
A ED-4701 00 307 A ED-4701 00 105 A ED-4701 00 203 A ED-4701	0°C ~ 100°C 15sec. 15sec. -30°C ~ 25°C ~ 100°C ~ 25°C 30min. 5min. 30min. 5min. 25°C ~ 65°C ~ -10°C 90%RH 24hrs./1cycle	20 cycles100 cycles10 cycles	0/50
00 307 A ED-4701 00 105 A ED-4701 00 203 A ED-4701	15sec. 15sec. -30°C ~ 25°C ~ 100°C ~ 25°C 30min. 5min. 25°C ~ 65°C ~ -10°C 90%RH 24hrs./1cycle	100 cycles 10 cycles	0/50
A ED-4701 00 105 A ED-4701 00 203 A ED-4701	-30°C ~ 25°C ~ 100°C ~ 25°C 30min. 5min. 30min. 5min. 25°C ~ 65°C ~ -10°C 90%RH 24hrs./1cycle	10 cycles	
00 105 A ED-4701 00 203 A ED-4701	30min. 5min. 30min. 5min. 25°C ~ 65°C ~ -10°C 90%RH 24hrs./1cycle	10 cycles	
A ED-4701 00 203 A ED-4701	25°C ~ 65°C ~ -10°C 90%RH 24hrs./1cycle	-	0/50
00 203 A ED-4701	90%RH 24hrs./1cycle	-	0/50
A ED-4701		1000 hrs	
	Ta=100°C	1000 hrs	
00 201		1000 ms.	0/50
A ED-4701	Ta=60°C, RH=90%	1000 hrs.	0/50
00 103			
A ED-4701	Ta=-30°C	1000 hrs.	0/50
00 202			
	Ta=25°C, IF=20mA	500 hrs.	0/50
	60°C, RH=90%, IF=10mA	500 hrs.	0/50
	Ta=-20°C, IF=10mA	1000 hrs.	0/50
A ED-4701	100 ~ 2000 ~ 100Hz Sweep 4min.	48min.	0/50
00 403	200m/s^2		
	3direction, 4cycles		
A ED-4702	3mm, 5 ± 1 sec.	1 time	0/50
			0/50
(00 403	Ta=-20°C, IF=10mA A ED-4701 100 ~ 2000 ~ 100Hz Sweep 4min. 00 403 200m/s ² 3direction, 4cycles A ED-4702 3mm, 5 ± 1 sec.	Ta=-20°C, IF=10mA 1000 hrs. A ED-4701 100 ~ 2000 ~ 100Hz Sweep 4min. 48min. 00 403 200m/s ² 3direction, 4cycles

(2) CRITERIA FOR JUDGING THE DAMAGE

CRITERIA FOR JUDGING THE DAMAGE							
			Criteria for Judgement				
Item	Symbol	Test Conditions	Min.	Max.			
Forward Voltage	VF	IF=10mA	-	U.S.L.*)× 1.1			
Reverse Current	Ir	Vr=5V	-	U.S.L.*) \times 2.0			
Luminous Intensity	Iv	IF=10mA	L.S.L.**)× 0.5	-			

*) U.S.L. : Upper Standard Level **) L.S.L. : Lower Standard Level

7.CAUTIONS

The LEDs are devices which are materialized by combining Blue LEDs and special phosphors. Consequently, the color of the LEDs is changed a little by an operating current. Care should be taken after due consideration when using LEDs.

(1) Moisture Proof Package

• When moisture is absorbed into the SMT package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package.

• The moisture proof package is made of an aluminum moisture proof bag with a zipper. A package of a moisture absorbent material (silica gel) is inserted into the aluminum moisture proof bag. The silica gel changes its color from blue to pink as it absorbs moisture.

(2) Storage

· Storage Conditions

Before opening the package :

The LEDs should be kept at 30°C or less and 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.

After opening the package :

The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.

• If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : more than 24 hours at $60 \pm 5^{\circ}C$

- Nichia LED electrode sections are comprised of a gold plated. The gold surface may be affected by environments which contain corrosive gases and so on. Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the User use the LEDs as soon as possible.
- Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

(3) Heat Generation

- Thermal design of the end product is of paramount importance. Please consider the heat generation of the LED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- \cdot The operating current should be decided after considering the ambient maximum temperature of LEDs.

(4) Soldering Conditions

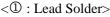
• The LEDs can be soldered in place using the reflow soldering method. Nichia cannot make a guarantee on the LEDs after they have been assembled using the dip soldering method.

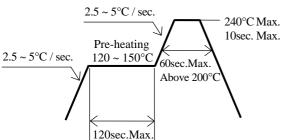
Reflow Soldering			Hand Soldering	
	Lead Solder	Lead-free Solder		
Pre-heat	120 ~ 150°C	180 ~ 200°C	Temperature	350°C Max.
Pre-heat time	120 sec. Max.	120 sec. Max.	Soldering time	3 sec. Max.
Peak temperature	240°C Max.	260°C Max.		(one time only)
Soldering time	10 sec. Max.	10 sec. Max.		
Condition	refer to	refer to		
	Temperature - profile $①$.	Temperature - profile ②.		
		(N ₂ reflow is recommended.)		

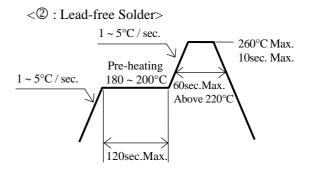
* After reflow soldering rapid cooling should be avoided.

[Temperature-profile (Surface of circuit board)]

Use the conditions shown to the under figure.

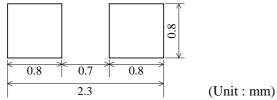






[Recommended soldering pad design]

Use the following conditions shown in the figure.



• Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.

- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- \cdot Reflow soldering should not be done more than two times.
- \cdot When soldering, do not put stress on the LEDs during heating.
- · After soldering, do not warp the circuit board.
- (5) Cleaning
 - It is recommended that isopropyl alcohol be used as a solvent for cleaning the LEDs. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not. Freon solvents should not be used to clean the LEDs because of worldwide regulations.
- Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition.
 Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

(6) Static Electricity

 \cdot Static electricity or surge voltage damages the LEDs.

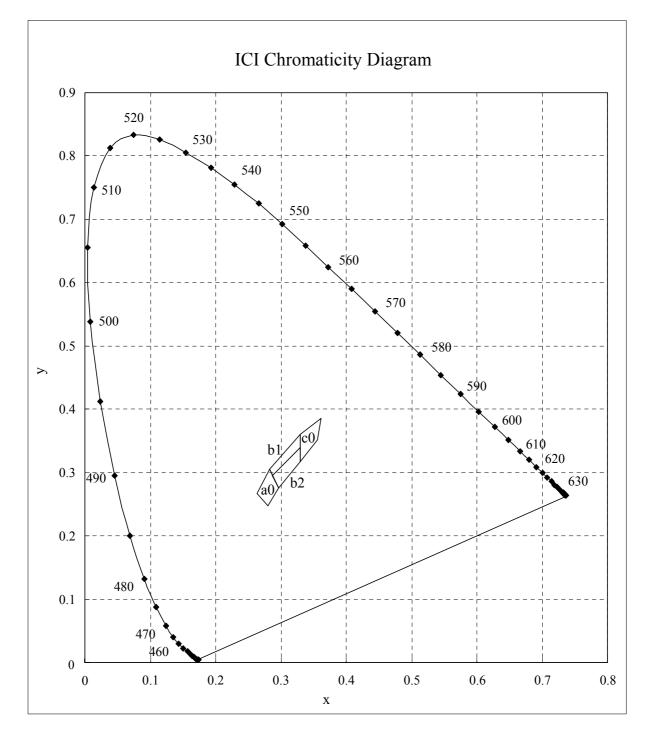
It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.

- \cdot All devices, equipment and machinery must be properly grounded.
- It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.
- When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a VF test at a lower current (below 1mA is recommended).
- Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.

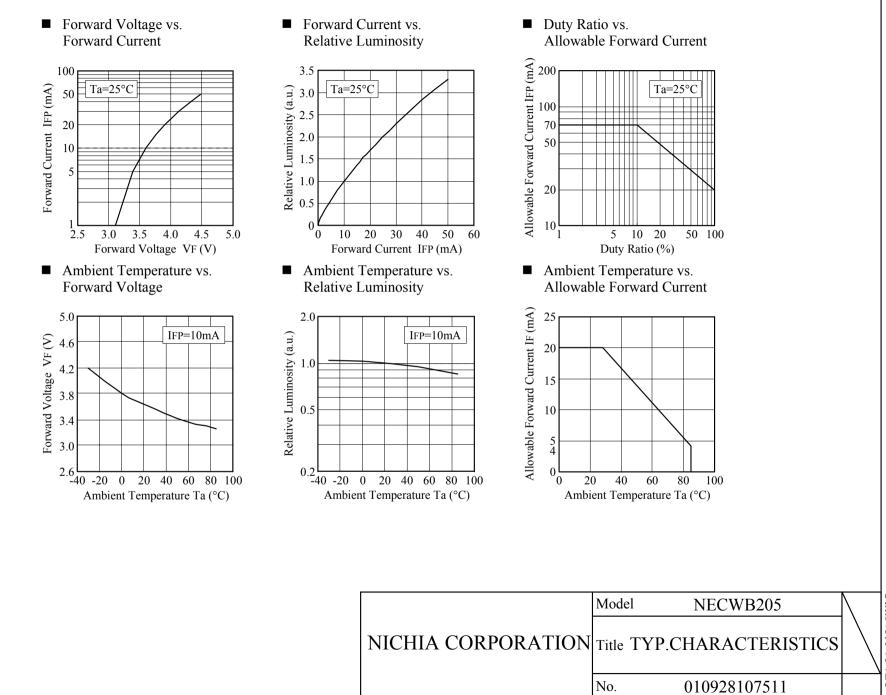
Criteria : (VF > 2.0V at IF=0.5mA)

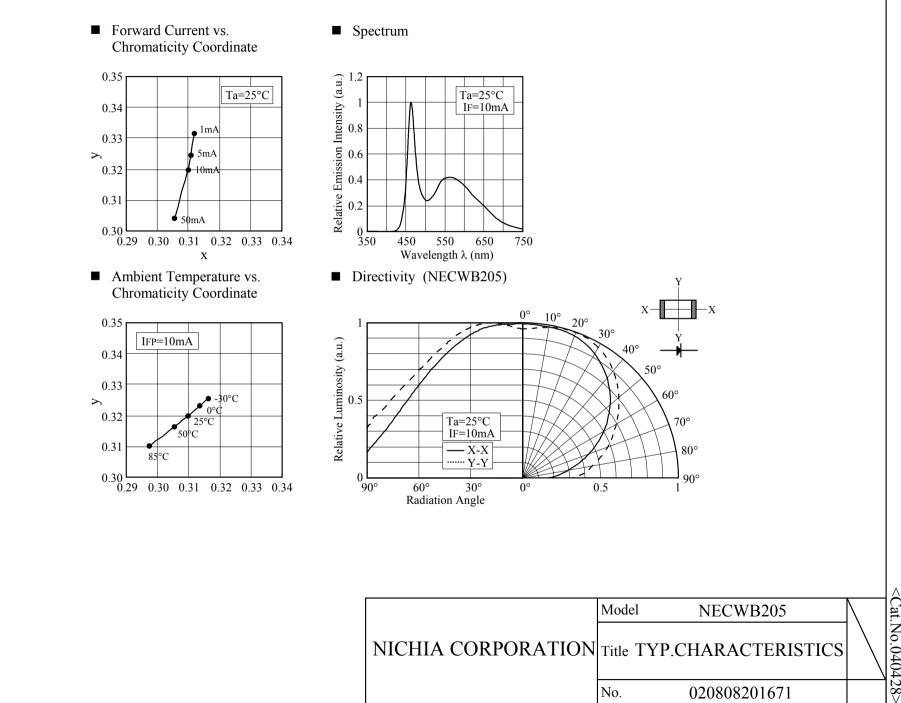
(7) Others

- \cdot Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- The LED light output is strong enough to injure human eyes. Precautions must be taken to prevent looking directly at the LEDs with unaided eyes for more than a few seconds.
- Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.
- The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult Nichia's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control systems, automobiles, traffic control equipment, life support systems and safety devices).
- User shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Nichia. When defective LEDs are found, the User shall inform Nichia directly before disassembling or analysis.
- \cdot The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
- \cdot The appearance and specifications of the product may be modified for improvement without notice.

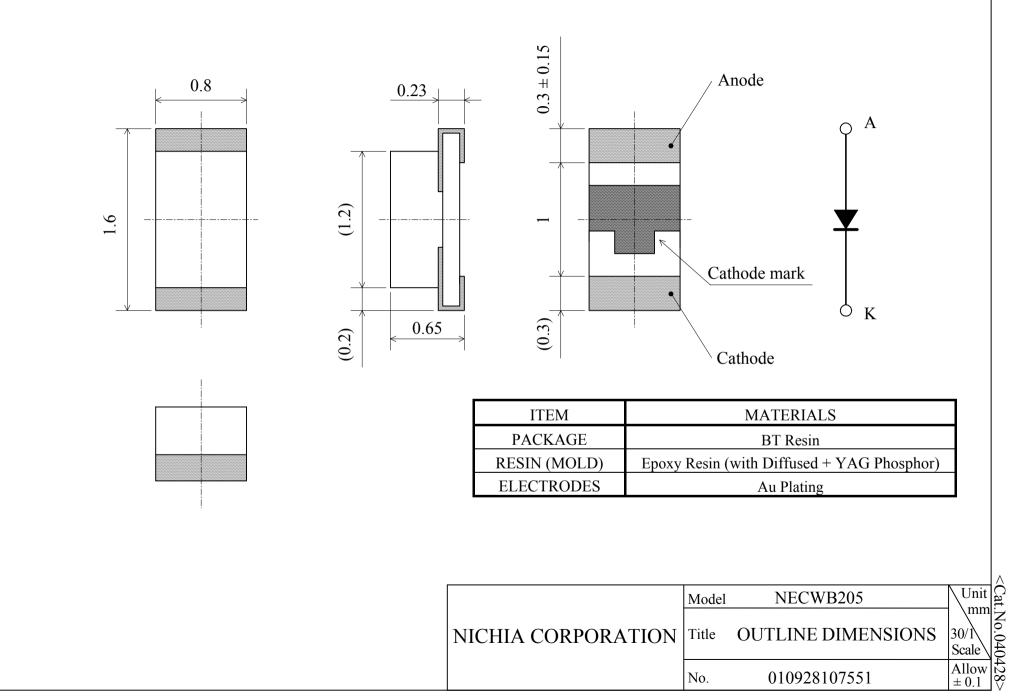


* Color Coordinates Measurement allowance is ± 0.01 .

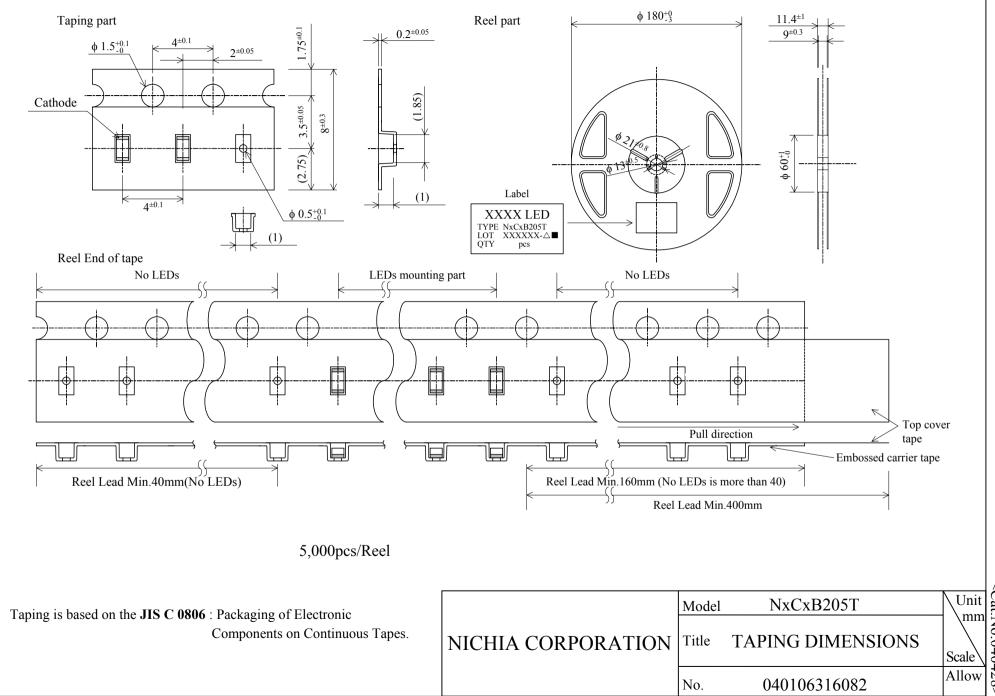




-9-



Nichia STSE-CC2076B <Cat.No.040428>



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